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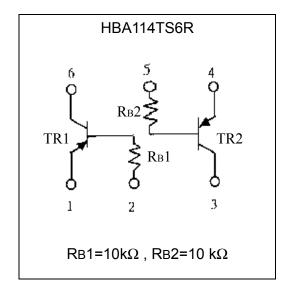
Dual PNP Digital Transistors

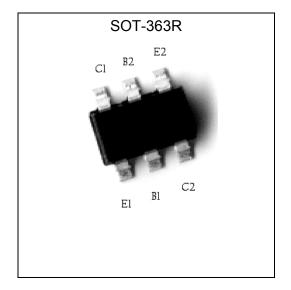
HBA114TS6R

Features

- •Built-in bias resistors enable the configuration of an inverter circuit without connecting external input resistors (see equivalent circuit).
- •The bias resistors consist of thin-film resistors with complete isolation to allow positive biasing of the input. They also have the advantage of almost completely eliminating parasitic effects.
- •Only the on/off conditions need to be set for operation, making device design easy.
- •Two DTA114T chips in a SOT-363 package.
- •Mounting by SOT-323 automatic mounting machines is possible.
- •Mounting cost and area can be cut in half.
- Transistor elements are independent, eliminating interference
- •Complements the HBC114TS6R

Equivalent Circuit





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Absolute Maximum Ratings (Each Transistor,Ta=25°C)

Parameter	Symbol	Limits	Unit
Collector-Base Voltage	Vcbo	-50	V
Collector-Emitter Voltage	Vceo	-50	V
Emitter-Base Voltage	Vebo	-5	V
Collector Current	Ic	-100	mA
Power Dissipation	Pd	200 (Note)	mW
Junction Temperature	Tj	150	°C
Storage Temperature	Tstg	-55~+150	°C

Note: 150mW per element must not be exceeded.

Characteristics (Each Transistor, Ta=25°C)

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Conditions
Collector-Base Breakdown Voltage	Vcbo	-50	-	-	V	Ic=-50μA
Collector-Emitter Breakdown Voltage	Vceo	-50	-	-	V	Ic=-1mA
Emitter-Base Breakdown Voltage	VEBO	-5	-	-	V	IE=-50μA
Collector-Base Cutoff Current	Ісво	-	•	-0.5	μΑ	V _{CB} =-50V
Emitter-Base Cutoff Current	Iево	-	-	-0.5	μΑ	$V_{EB}=-4V$
Collector-Emitter Saturation Voltage	VCE(sat)	-	0.1	-0.3	V	Ic=-10mA, IB=-1mA
DC Current Gain	hfe	100	-	600	-	Vce=-5V, Ic=-1mA
Input Resistance	R	7	10	13	kΩ	-
Transition Frequency	fт	-	250	-	MHz	Vce=-10V, Ic=-5mA, f=100MHz *

^{*} Transition frequency of the device

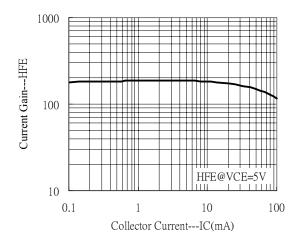
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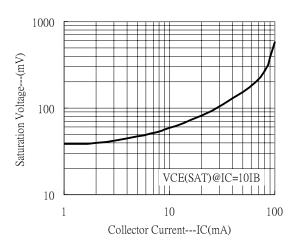
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Characteristic Curves

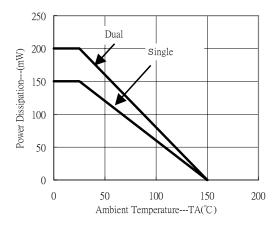
Current Gain vs Collector Current



Saturation Voltage vs Collector Current



Power Derating Curves



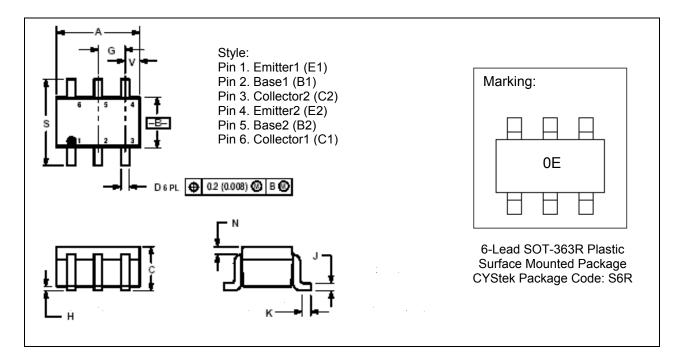


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SOT-363R Dimension



*:Typical

DIM	Inches		Millimeters		DIM	Inches		Millimeters	
	Min.	Max.	Min.	Max.	ווועו	Min.	Max.	Min.	Max.
Α	0.071	0.087	1.8	2.2	J	0.004	0.010	0.1	0.25
В	0.045	0.053	1.15	1.35	K	0.004	0.012	0.1	0.30
С	0.031	0.043	0.8	1.1	N	0.008 REF		0.20 REF	
D	0.004	0.012	0.1	0.3	S	0.079	0.087	2.00	2.20
G	0.026	BSC	0.65BSC		Υ	0.012	0.016	0.30	0.40
Н	-	0.004	-	0.1					

Notes: 1.Controlling dimension: millimeters.

2.Maximum lead thickness includes lead finish thickness, and minimum lead thickness is the minimum thickness of base material. 3.If there is any question with packing specification or packing method, please contact your local CYStek sales office.

Material:

- Lead : 42 Alloy ; solder plating
- Mold Compound: Epoxy resin family, flammability solid burning class:UL94V-0

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